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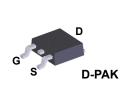
## ON Semiconductor® FQD4P40 P-Channel QFET® MOSFET -400 V, -2.7 A, 3.1 Ω

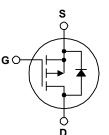
## Description

These P-Channel enhancement mode power field effect transistors are produced using ON Semiconductor's proprietary, planar stripe, DMOS technology. This advanced technology has been especially tailored to minimize on-state resistance, provide superior switching performance, and withstand high energy pulse in the avalanche and commutation mode. These devices are well suited for electronic lamp ballast based on complimentary half bridge.

#### Features

- 2.7 A, -400 V,  $R_{DS(on)}$  = 3.1  $\Omega$  (Max.) @ V\_{GS} = -10 V,  $I_{D}$  = -1.35 A
- Low Gate Charge (Typ. 18 nC)
- Low Crss (Typ. 11 pF)
- 100% Avalanche Tested





#### Absolute Maximum Ratings T<sub>c</sub> = 25°C unless otherwise noted.

Symbol	Parameter		FQD4P40TM	Unit	
V <sub>DSS</sub>	Drain-Source Voltage		-400	V	
I <sub>D</sub>	Drain Current - Continuous (T <sub>C</sub> = 25	-2.7	А		
	- Continuous (T <sub>C</sub> = 10	-1.71	Α		
I <sub>DM</sub>	Drain Current - Pulsed	(Note 1)	-10.8	A	
V <sub>GSS</sub>	Gate-Source Voltage		± 30	V	
E <sub>AS</sub>	Single Pulsed Avalanche Energy	(Note 2)	260	mJ	
I <sub>AR</sub>	Avalanche Current	(Note 1)	-2.7	A	
E <sub>AR</sub>	Repetitive Avalanche Energy	(Note 1)	5.0	mJ	
dv/dt	Peak Diode Recovery dv/dt	(Note 3)	-4.5	V/ns	
P <sub>D</sub>	Power Dissipation (T <sub>A</sub> = 25°C) *	2.5	W		
	Power Dissipation (T <sub>C</sub> = 25°C)		50	W	
	- Derate above 25°C	0.4	W/°C		
T <sub>J</sub> , T <sub>STG</sub>	Operating and Storage Temperature Range		-55 to +150	°C	
TL	Maximum lead temperature for soldering purposes, 1/8" from case for 5 seconds		300	°C	

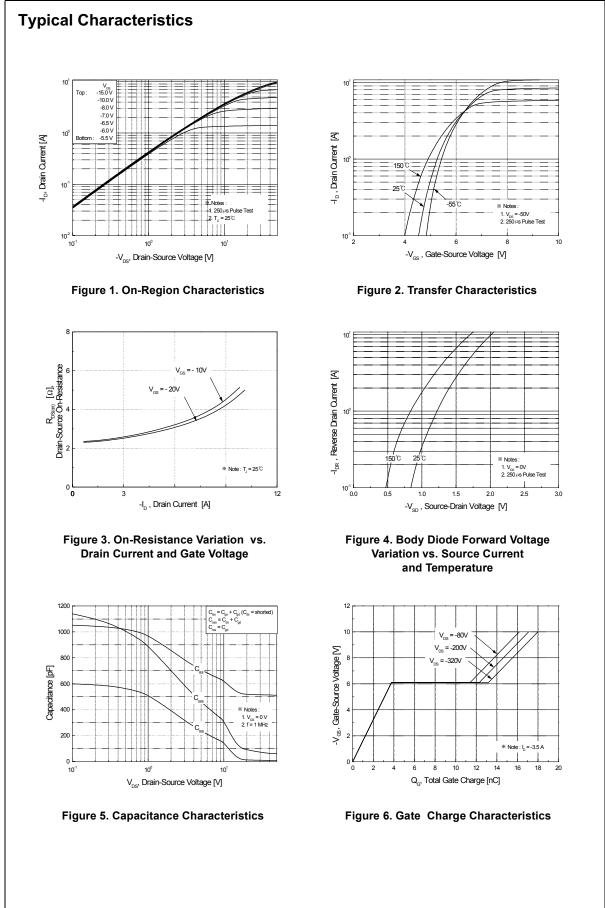
## **Thermal Characteristics**

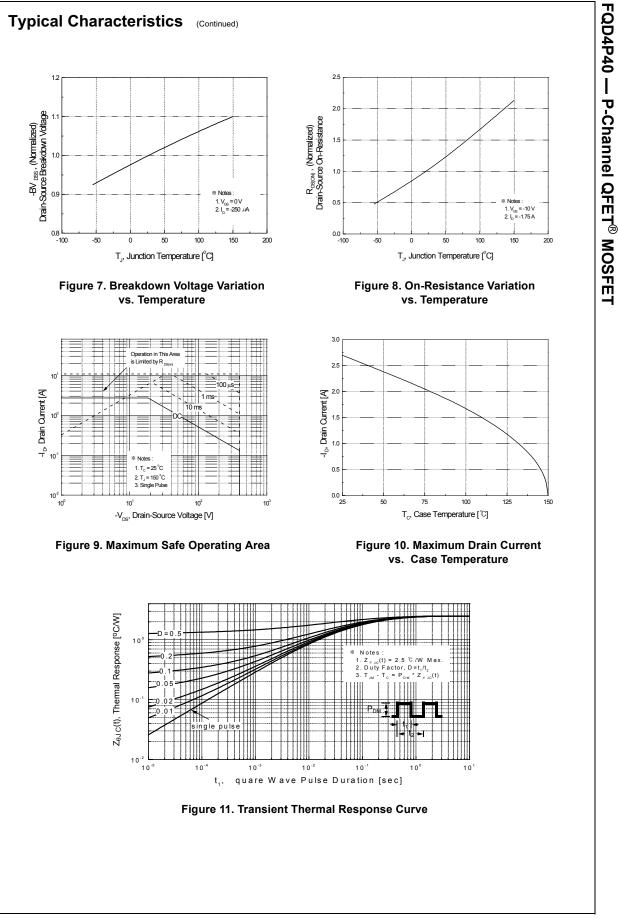
Symbol	Parameter	FQD4P40TM	Unit
$R_{\theta JC}$	Thermal Resistance, Junction to Case, Max.	2.5	
<b>D</b>	Thermal Resistance, Junction to Ambient (Minimum Pad of 2-oz Copper), Max.	110	°C/W
$R_{\thetaJA}$	Thermal Resistance, Junction to Ambient (*1 in <sup>2</sup> Pad of 2-oz Copper), Max.	50	

		Top Mark P	ackage	Packing Method	Reel	Size	Tape W	idth C	luantity
		FQD4P40	DPAK	Tape and Reel	330	330 mm		n 25	2500 units
lectri	cal Ch	aracteristics T <sub>c</sub> = 25%	C unless otherv	vise noted.					
Symbol		Parameter		Test Conditions		Min	Тур	Max	Unit
Off Cha	aracteris	stics							
BV <sub>DSS</sub>	Drain-Source Breakdown Voltage		V <sub>GS</sub> =	$V_{GS}$ = 0 V, I <sub>D</sub> = -250 µA		-400			V
ΔBV <sub>DSS</sub> / ΔT <sub>J</sub>	Breakdo Coefficie	wn Voltage Temperature ent	I <sub>D</sub> = -2	$I_D$ = -250 µA, Referenced to 25°C			0.36		V/°C
I <sub>DSS</sub>	Zero Gate Voltage Drain Current		V <sub>DS</sub> =	V <sub>DS</sub> = -400 V, V <sub>GS</sub> = 0 V				-1	μA
			V <sub>DS</sub> =	V <sub>DS</sub> = -320 V, T <sub>C</sub> = 125°C				-10	μA
I <sub>GSSF</sub>	Gate-Bo	dy Leakage Current, Forwa		$V_{GS}$ = -30 V, $V_{DS}$ = 0 V				-100	nA
I <sub>GSSR</sub>	Gate-Bo	dy Leakage Current, Revers	se V <sub>GS</sub> =	30 V, $V_{DS}$ = 0 V				100	nA
On Cha	aracteris	stics							
V <sub>GS(th)</sub>	Gate Th	reshold Voltage	V <sub>DS</sub> =	V <sub>GS</sub> , I <sub>D</sub> = -250 μA		-3.0		-5.0	V
R <sub>DS(on)</sub>	Static D On-Resi	rain-Source stance	V <sub>GS</sub> =	-10 V, I <sub>D</sub> = -1.35 A			2.44	3.1	Ω
9 <sub>FS</sub>	Forward	Transconductance	V <sub>DS</sub> =	-50 V, I <sub>D</sub> = -1.35 A			2.5		S
C <sub>iss</sub> C <sub>oss</sub> C <sub>rss</sub>	Input Ca Output 0	acteristics pacitance Capacitance • Transfer Capacitance	V <sub>DS</sub> =	-25 V, V <sub>GS</sub> = 0 V, MHz			520 80 11	680 105 15	pF pF pF
100									
Switch	ind Cha	racteristics							
		racteristics Delay Time		000.1/1 0.5 4			13	35	ns
t <sub>d(on)</sub>	Turn-On			-200 V, I <sub>D</sub> = -3.5 A,			13 55	35 120	ns ns
t <sub>d(on)</sub> t <sub>r</sub>	Turn-On Turn-On	Delay Time	V <sub>DD</sub> =						
t <sub>d(on)</sub> t <sub>r</sub> t <sub>d(off)</sub>	Turn-On Turn-On Turn-Off	Delay Time Rise Time			(Note 4)		55	120	ns
t <sub>d(on)</sub> t <sub>r</sub> t <sub>d(off)</sub> t <sub>f</sub>	Turn-On Turn-On Turn-Off Turn-Off	Delay Time Rise Time Delay Time	R <sub>G</sub> = 2	25 Ω	(Note 4)		55 35	120 80	ns ns
t <sub>d(on)</sub> t <sub>r</sub> t <sub>d(off)</sub> t <sub>f</sub> Q <sub>g</sub> Q <sub>gs</sub>	Turn-On Turn-On Turn-Off Turn-Off Total Ga	Delay Time Rise Time Delay Time Fall Time	R <sub>G</sub> = 2	-320 V, I <sub>D</sub> = -3.5 A,	(Note 4)		55 35 37	120 80 85	ns ns ns
t <sub>d(on)</sub> t <sub>r</sub> t <sub>d(off)</sub> t <sub>f</sub> Q <sub>g</sub> Q <sub>gs</sub>	Turn-On Turn-On Turn-Off Turn-Off Total Ga Gate-So	Delay Time Rise Time Delay Time Fall Time te Charge	R <sub>G</sub> = 2	-320 V, I <sub>D</sub> = -3.5 A,	(Note 4) (Note 4)		55 35 37 18	120 80 85 23	ns ns ns nC
t <sub>d(on)</sub> t <sub>r</sub> t <sub>d(off)</sub> t <sub>f</sub> Q <sub>gs</sub> Q <sub>gd</sub> <b>Drain-S</b>	Turn-On Turn-On Turn-Off Turn-Off Total Ga Gate-So Gate-Dr	Delay Time Rise Time Delay Time Fall Time te Charge urce Charge	$R_{G} = 2$ $V_{DS} =$ $V_{GS} =$ and Max	-320 V, I <sub>D</sub> = -3.5 A, -10 V <b>kimum Ratings</b>	(Note 4)		55 35 37 18 3.8	120 80 85 23	ns ns ns nC nC
<sup>t</sup> d(on) tr Qg Qgs Qgd <b>Drain-S</b>	Turn-On Turn-On Turn-Off Turn-Off Total Ga Gate-So Gate-Dr Source I Maximu	Delay Time Rise Time Delay Time Fall Time te Charge urce Charge ain Charge Diode Characteristics	R <sub>G</sub> = 2 V <sub>DS</sub> = V <sub>GS</sub> = Diode Forv e Forward	25 Ω -320 V, I <sub>D</sub> = -3.5 A, -10 V <b>kimum Ratings</b> vard Current Current	(Note 4)		55 35 37 18 3.8 9.4	120 80 85 23  	ns ns nC nC nC
t <sub>d(on)</sub> t <sub>r</sub> t <sub>d(off)</sub> t <sub>f</sub> Q <sub>gs</sub> Q <sub>gd</sub> <b>Drain-S</b> I <sub>S</sub>	Turn-On Turn-Off Turn-Off Turn-Off Total Ga Gate-So Gate-Dr Source I Maximut Maximut	Delay Time Rise Time Delay Time Fall Time te Charge aurce Charge ain Charge Diode Characteristics m Continuous Drain-Source	R <sub>G</sub> = 2 V <sub>DS</sub> = V <sub>GS</sub> = Diode Forv e Forward	-320 V, I <sub>D</sub> = -3.5 A, -10 V <b>kimum Ratings</b> vard Current	(Note 4)	    	55 35 37 18 3.8 9.4	120 80 85 23   	ns ns nC nC nC
t <sub>d(on)</sub> t <sub>r</sub> t <sub>d(off)</sub> t <sub>f</sub> Q <sub>g</sub> Q <sub>gs</sub> Q <sub>gd</sub>	Turn-On Turn-Off Turn-Off Turn-Off Total Ga Gate-So Gate-Dr Source I Maximu Maximu Drain-So	Delay Time Rise Time Delay Time Fall Time te Charge urce Charge ain Charge Diode Characteristics m Continuous Drain-Source m Pulsed Drain-Source Dioc	$R_{G} = 2$ $V_{DS} =$ $V_{GS} =$ $V_{GS} =$ $Diode Forward$ $e Forward$ $e V_{GS} =$ $V_{GS} =$	25 Ω -320 V, I <sub>D</sub> = -3.5 A, -10 V <b>kimum Ratings</b> vard Current Current	(Note 4)	     	55 35 37 18 3.8 9.4	120 80 85 23      	ns ns nC nC nC A A

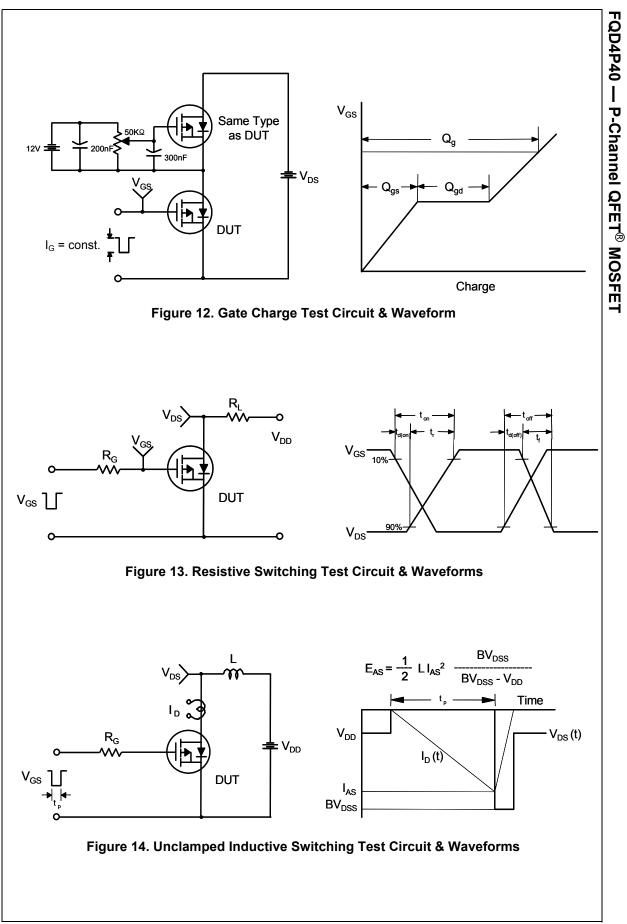
FQD4P40 — P-Channel QFET<sup>®</sup> MOSFET

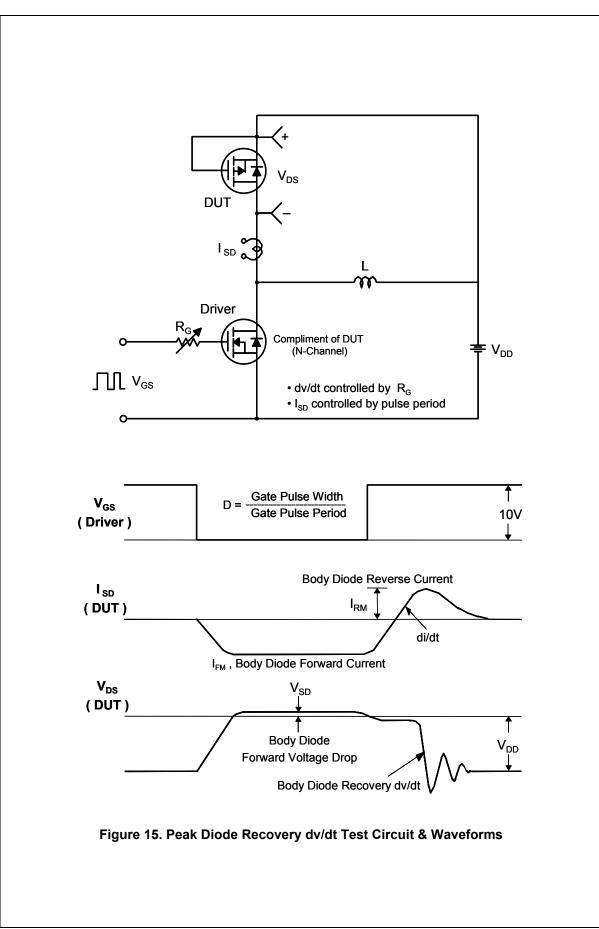
3.  $I_{SD} \le -3.5$  A, di/dt  $\le 200$  A/µs,  $V_{DD} \le BV_{DSS}$ , starting 4. Essentially independent of operating temperature.

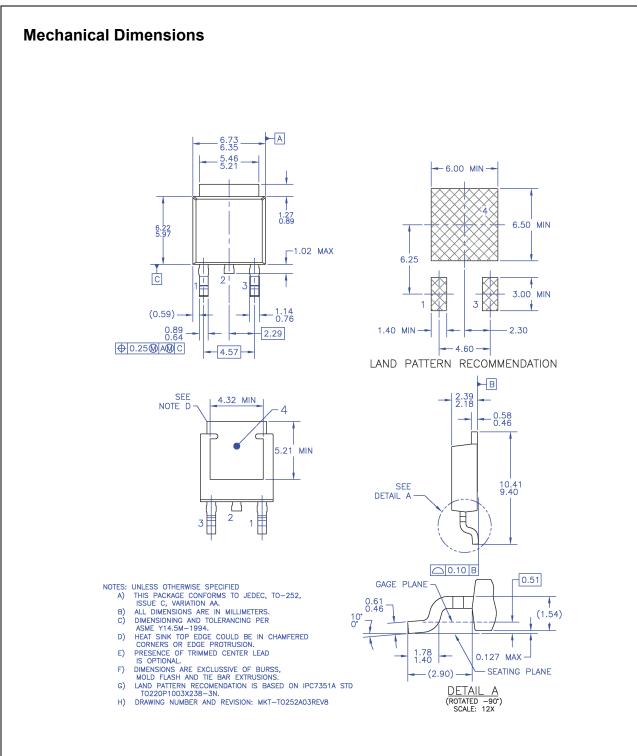




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## Figure 16. TO252 (D-PAK), Molded, 3-Lead, Option AA&AB

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